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U.S. UTILITY Patent Application

PATENT NUMBER and
ISSUE DATE

APPL NUM	FILING DATE	CLASS	SUBCLASS	GAU	EXAMINER
10067551	02/05/2002	38129	840	372	Chang

****APPLICANTS:** Downes Francis; Farquhar Donald; Foster Elizabeth; Japp Robert;
Jonas Gerald; Kresge John; Sebesta Robert; Stone David; Wilcox James;

****CONTINUING DATA VERIFIED:**
THIS APPLICATION IS A DIV OF 09/540,172 03/31/2000 PAT 6,373,717
WHICH IS A CIP OF 09/346,356 07/02/1999 PAT 6,351,393

**** FOREIGN APPLICATIONS VERIFIED:**

PG-PUB <input type="checkbox"/> DO NOT PUBLISH <input type="checkbox"/>	RESCIND <input type="checkbox"/>
Foreign priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no	ATTORNEY DOCKET NO
35 USC 115 conditions met <input type="checkbox"/> yes <input type="checkbox"/> no	EN9-97-075US3
Verified and Acknowledged Examiners's initials	
TITLE : Electronic package with high density interconnect layer	

U.S. DEPT. OF COMM./PAT. & TM.-PTO-436L (Rev. 12-94)

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
		Total Claims	Print Claim for O.G
ISSUE FEE		DRAWING	
Amount Due	Date Paid	Sheets Drwg.	Figs. Drwg.
		Print Fig.	
<input type="checkbox"/> TERMINAL DISCLAIMER		Application Examiner	
		PREPARED FOR ISSUE	
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